

# FMV12N50E

FUJI POWER MOSFET

## Super FAP-E<sup>3</sup> series

## N-CHANNEL SILICON POWER MOSFET

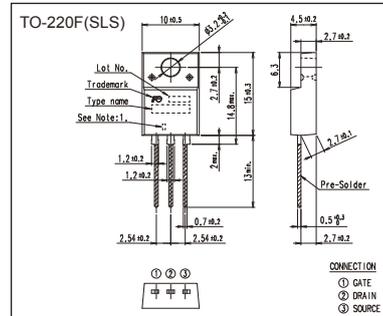
### ■ Features

- Maintains both low power loss and low noise
- Lower R<sub>DS(on)</sub> characteristic
- More controllable switching dv/dt by gate resistance
- Smaller V<sub>GS</sub> ringing waveform during switching
- Narrow band of the gate threshold voltage (3.0±0.5V)
- High avalanche durability

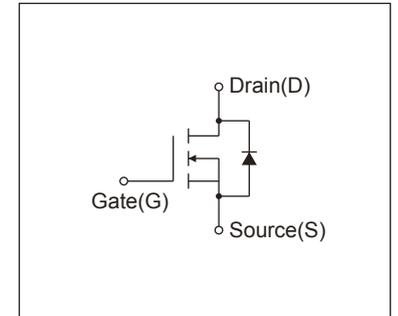
### ■ Applications

- Switching regulators
- UPS (Uninterruptible Power Supply)
- DC-DC converters

### ■ Outline Drawings [mm]



### ■ Equivalent circuit schematic



### ■ Maximum Ratings and Characteristics

#### ● Absolute Maximum Ratings at T<sub>c</sub>=25°C (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain-Source Voltage	V <sub>DS</sub>	500	V	
	V <sub>DSS</sub>	500	V	V <sub>GS</sub> = -30V
Continuous Drain Current	I <sub>D</sub>	±12	A	
Pulsed Drain Current	I <sub>DP</sub>	±48	A	
Gate-Source Voltage	V <sub>GS</sub>	±30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	I <sub>AR</sub>	12	A	Note*1
Non-Repetitive Maximum Avalanche Energy	E <sub>AS</sub>	400	mJ	Note*2
Repetitive Maximum Avalanche Energy	E <sub>AR</sub>	6.0	mJ	Note*3
Peak Diode Recovery dV/dt	dV/dt	6.5	kV/μs	Note*4
Peak Diode Recovery -di/dt	-di/dt	100	A/μs	Note*5
Maximum Power Dissipation	P <sub>D</sub>	2.16	W	T <sub>a</sub> =25°C
		60		T <sub>c</sub> =25°C
Operating and Storage Temperature range	T <sub>ch</sub>	150	°C	
	T <sub>stg</sub>	-55 to +150	°C	
Isolation Voltage	V <sub>ISO</sub>	2	kVrms	t = 60sec, f = 60Hz

#### ● Electrical Characteristics at T<sub>c</sub>=25°C (unless otherwise specified)

Description	Symbol	Conditions	min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V	500	-	-	V
Gate Threshold Voltage	V <sub>GS</sub> (th)	I <sub>D</sub> =250μA, V <sub>DS</sub> =V <sub>GS</sub>	2.5	3.0	3.5	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =500V, V <sub>GS</sub> =0V	-	-	25	μA
		V <sub>DS</sub> =400V, V <sub>GS</sub> =0V	-	-	250	
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V	-	10	100	nA
Drain-Source On-State Resistance	R <sub>DS</sub> (on)	I <sub>D</sub> =6A, V <sub>GS</sub> =10V	-	0.444	0.52	Ω
Forward Transconductance	g <sub>fs</sub>	I <sub>D</sub> =6A, V <sub>DS</sub> =25V	6.5	13	-	S
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =25V	-	1600	2400	pF
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> =0V	-	160	240	
Reverse Transfer Capacitance	C <sub>rss</sub>	f=1MHz	-	11.5	17.5	
Turn-On Time	td(on)	V <sub>cc</sub> =300V	-	20	30	ns
	tr	V <sub>GS</sub> =10V	-	9	13.5	
Turn-Off Time	td(off)	I <sub>D</sub> =6A	-	100	150	
	tf	R <sub>G</sub> =15Ω	-	18	27	
Total Gate Charge	Q <sub>G</sub>	V <sub>cc</sub> =300V	-	47	70.5	nC
Gate-Source Charge	Q <sub>GS</sub>	I <sub>D</sub> =12A	-	10.5	16	
Gate-Drain Charge	Q <sub>GD</sub>	V <sub>GS</sub> =10V	-	14	21	
Avalanche Capability	I <sub>AV</sub>	L=2.12mH, T <sub>ch</sub> =25°C	12	-	-	A
Diode Forward On-Voltage	V <sub>SD</sub>	I <sub>F</sub> =12A, V <sub>GS</sub> =0V, T <sub>ch</sub> =25°C	-	0.88	1.32	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =12A, V <sub>GS</sub> =0V	-	0.36	-	μs
Reverse Recovery Charge	Q <sub>rr</sub>	-di/dt=100A/μs, T <sub>ch</sub> =25°C	-	4.1	-	μC

#### ● Thermal Characteristics

Description	Symbol	Test Conditions	min.	typ.	max.	Unit
Thermal resistance	R <sub>th</sub> (ch-c)	Channel to Case			2.083	°C/W
	R <sub>th</sub> (ch-a)	Channel to Ambient			58.0	°C/W

Note \*1 : T<sub>ch</sub>≤150°C

Note \*2 : Stating T<sub>ch</sub>=25°C, I<sub>AS</sub>=5A, L=29.2mH, V<sub>cc</sub>=50V, R<sub>G</sub>=50Ω

E<sub>AS</sub> limited by maximum channel temperature and avalanche current.  
See to 'Avalanche Energy' graph.

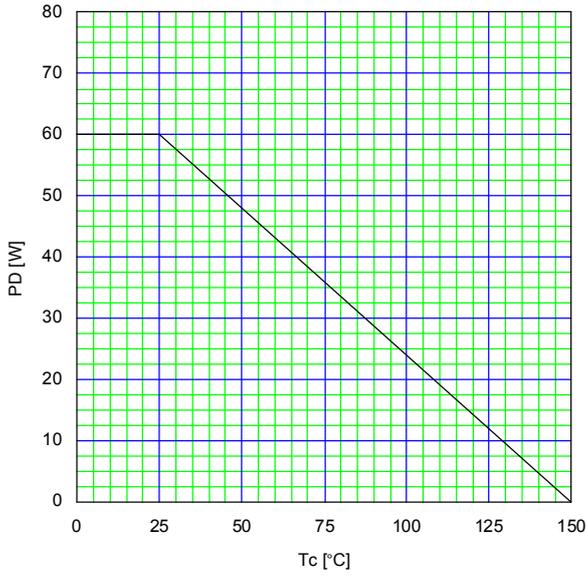
Note \*3 : Repetitive rating : Pulse width limited by maximum channel temperature.

See to the 'Transient Thermal impedance' graph.

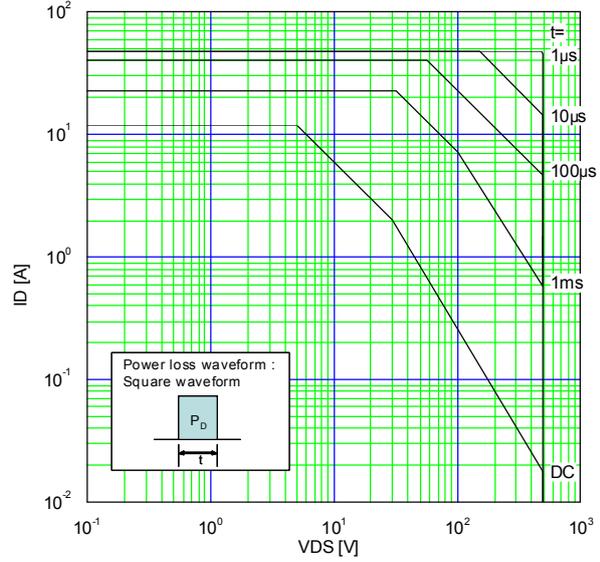
Note \*4 : I<sub>F</sub>≤-I<sub>D</sub>, -di/dt=100A/μs, V<sub>cc</sub>≤BV<sub>DSS</sub>, T<sub>ch</sub>≤150°C.

Note \*5 : I<sub>F</sub>≤-I<sub>D</sub>, dv/dt=6.5kV/μs, V<sub>cc</sub>≤BV<sub>DSS</sub>, T<sub>ch</sub>≤150°C.

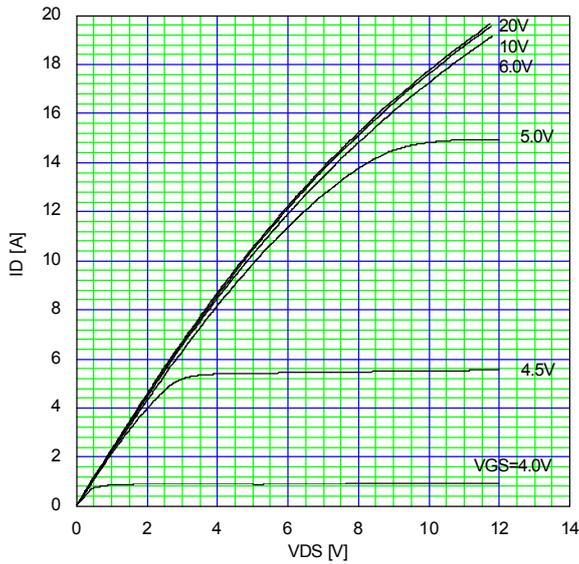
Allowable Power Dissipation  
 $PD=f(T_c)$



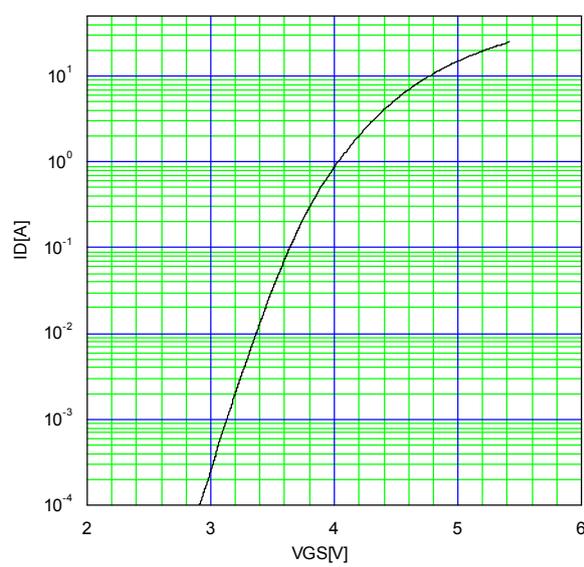
Safe Operating Area  
 $I_D=f(V_{DS}):Duty=0(\text{Single pulse}),T_c=25^\circ\text{C}$



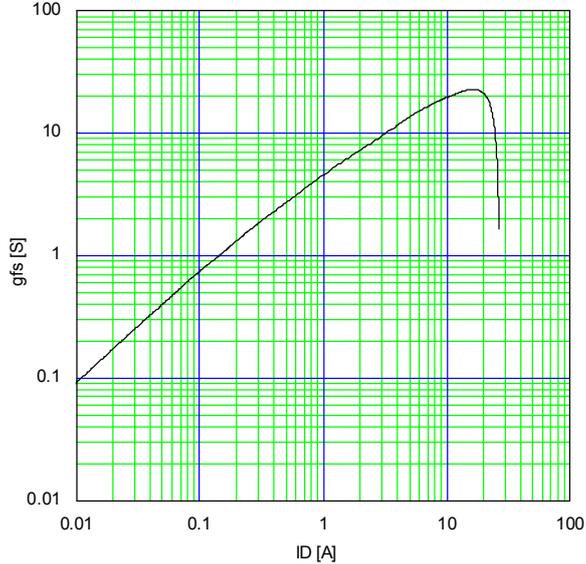
Typical Output Characteristics  
 $I_D=f(V_{DS}):80\mu\text{s pulse test},T_{ch}=25^\circ\text{C}$



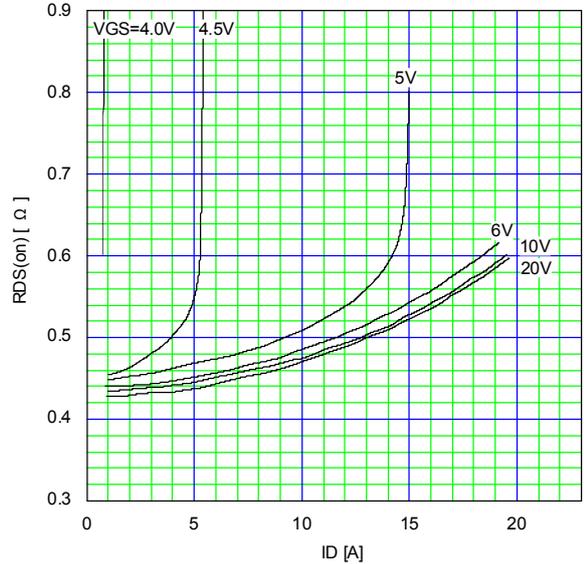
Typical Transfer Characteristic  
 $I_D=f(V_{GS}):80\mu\text{s pulse test},V_{DS}=25\text{V},T_{ch}=25^\circ\text{C}$

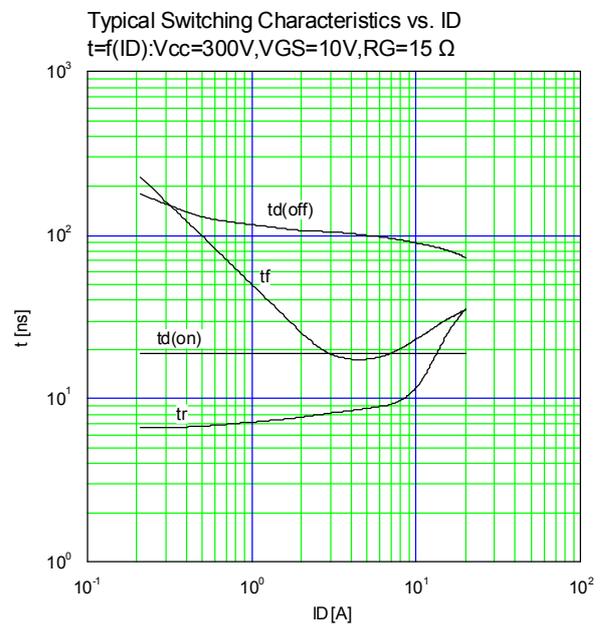
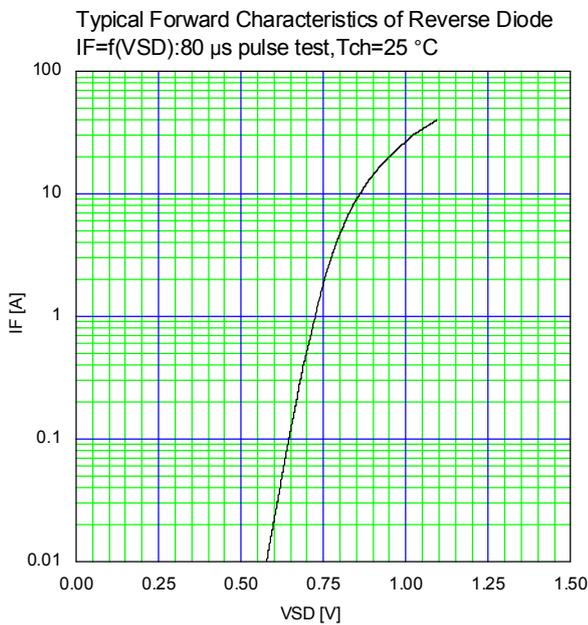
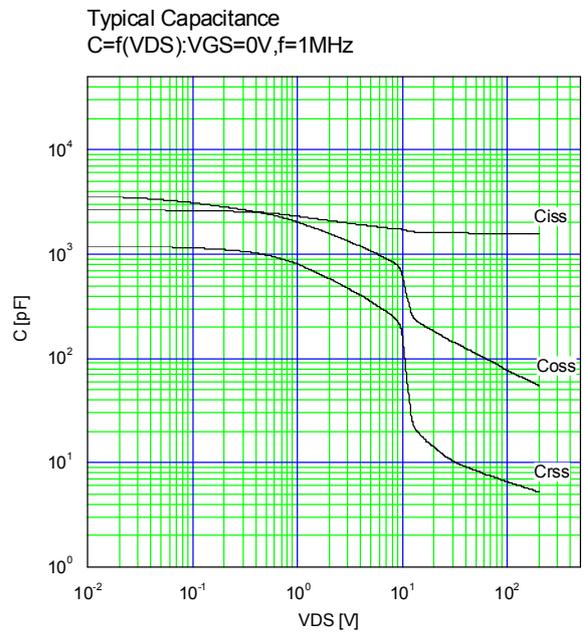
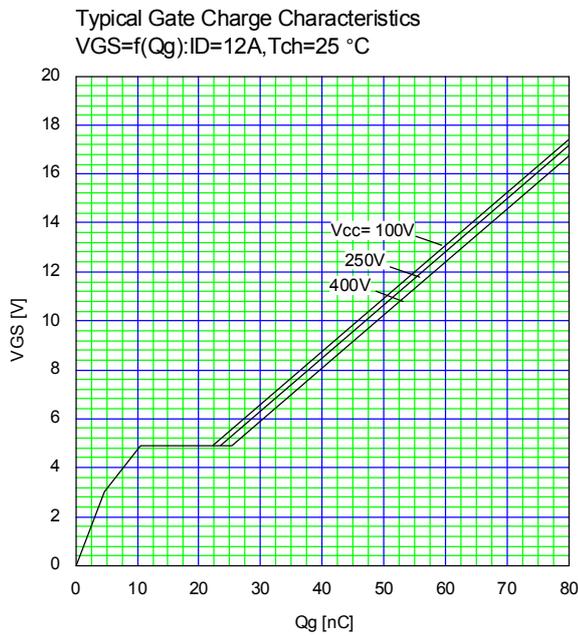
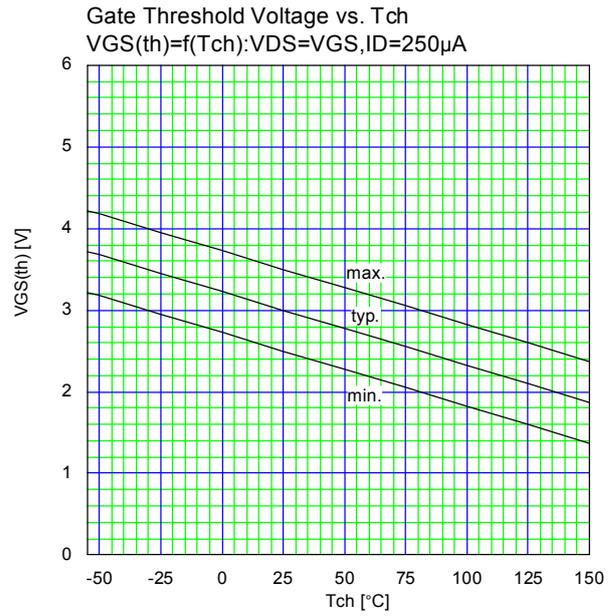
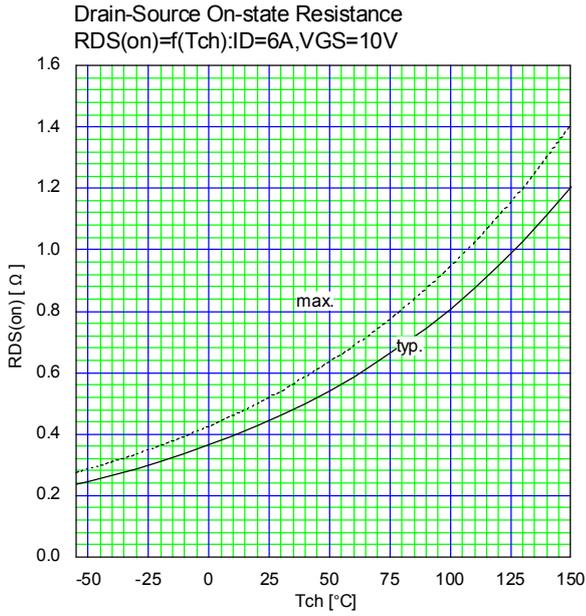


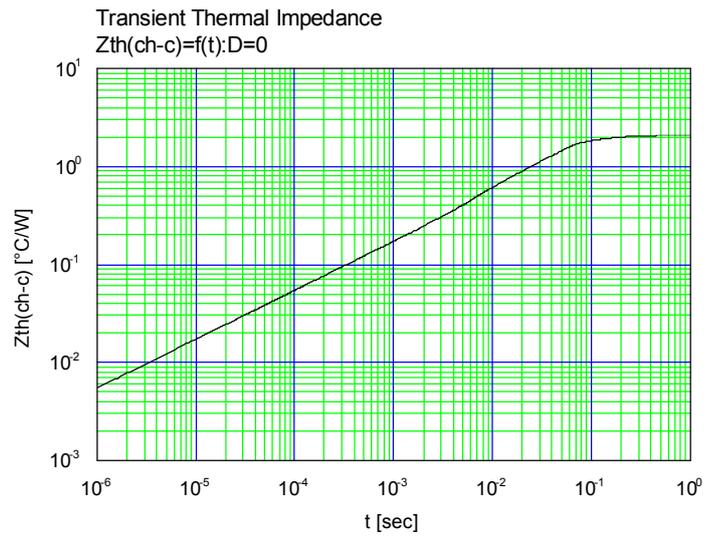
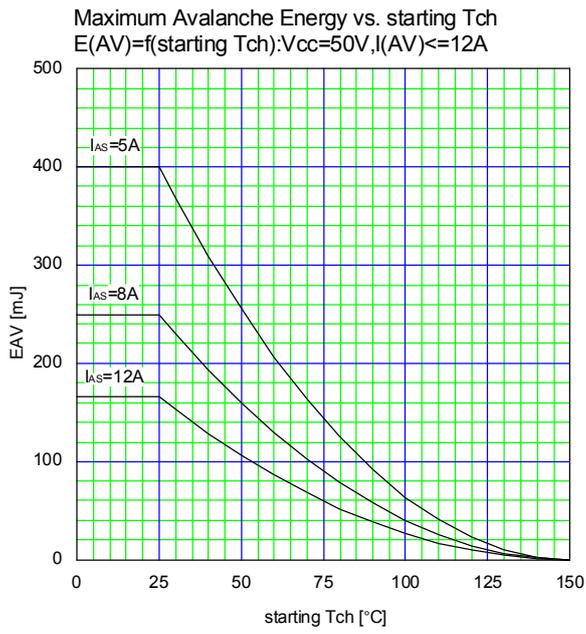
Typical Transconductance  
 $g_{fs}=f(I_D):80\mu\text{s pulse test},V_{DS}=25\text{V},T_{ch}=25^\circ\text{C}$



Typical Drain-Source on-state Resistance  
 $R_{DS(on)}=f(I_D):80\mu\text{s pulse test},T_{ch}=25^\circ\text{C}$







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